



FOR IMMEDIATE RELEASE

Contact:

ASE, Inc.

Room 1901, No. 333, Section 1
Keelung Road, Taipei, Taiwan, 110

Joseph Tung, CFO/Vice President

Allen Kan, Manager

ir@aseglobal.com

Tel: + 886.2.8780.5489

Fax: + 886.2.2757.6121

<http://www.aseglobal.com>

**REVISION TO THE ANNOUNCEMENT:
ASE INC. AND TWO SUBSIDIARIES' BOD HAVE
RESOLVED TO LAUNCH A CASH AND STOCK TENDER OFFER TO
BUY THE OUTSTANDING COMMON SHARES OF USI**

Taipei, Taiwan, R.O.C., November 18, 2009 - Advanced Semiconductor Engineering, Inc. (TAIEX: 2311, NYSE: ASX) (hereinafter "ASE", or the "Company") along with its two subsidiaries, J&R Holding Limited and ASE Test Limited, today announced that the Company's Board of Directors has resolved to launch a cash and stock tender offer to buy all of the outstanding common shares of Universal Scientific Industrial Co., Ltd. (TAIEX: 2350) (hereinafter "USI") at NT\$21 per share. USI's shareholders will receive 0.34 ASE common shares, owned by ASE's two subsidiaries (totaling 306,596,000 shares), for each USI common share plus cash (equivalent to NT\$21 less 0.34 multiplied by the lowest of the average closing price of ASE's common shares for the last one, three and five trading days prior to the last day of the tender offer period).

ASE plans to conduct the tender offer from November 18th, 2009 at 12:00pm TST (GMT+8:00) through January 6th, 2010 at 3:30pm TST (GMT+8:00). Currently, ASE and its subsidiaries own 18.2% of USI's outstanding common shares. The Company (including its subsidiaries) plans to purchase all outstanding shares of USI that it does not already own.

Safe Harbor Notice

This press release contains "forward-looking statements" within the meaning of Section 27A of the United States Securities Act of 1933, as amended, and Section 21E of the United States Securities Exchange Act of 1934, as amended, including statements regarding our future results of operations and business prospects. Although these forward-looking statements, which may include statements regarding our future results of operations, financial condition or business prospects, are based on our own information and information from other sources we believe to be reliable, you should not place undue reliance on these forward-looking statements, which apply only as of the date of this presentation. The words "anticipate", "believe", "estimate", "expect", "intend", "plan" and similar expressions, as they relate to us, are intended to identify these forward-looking statements in this presentation. Our actual results of operations, financial condition or business prospects may differ materially from those expressed or implied in these forward-looking statements for a variety of reasons, including risks associated with cyclicity and market conditions in the semiconductor industry; demand for the outsourced semiconductor packaging and testing services we offer and for such outsourced services generally; the highly competitive semiconductor industry; our ability to introduce new packaging, interconnect materials and testing technologies in order to remain competitive; our ability to successfully integrate pending and future mergers and acquisitions; international business activities; our business strategy; general economic and political conditions, including the recent global financial crisis; possible disruptions in commercial activities caused by natural or human-induced disasters; our future expansion plans and capital expenditures; the strained relationship between the Republic of China and the People's Republic of China; fluctuations in foreign currency exchange rates; and other factors. For a discussion of these risks and other factors, please see the documents we file from time to time with the Securities and Exchange Commission, including our 2008 Annual Report on Form 20-F filed on June 24, 2009.